

Search Notes

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|---|------------------|---------|------------------|
| L1 | 2347 | (438/622).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/17 17:42 |
| L2 | 2223 | (438/637).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/17 17:45 |
| S1 | 855 | electroless\$2 with plat\$3 and grind\$3 and laser | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 01:53 |
| S2 | 487 | electroless\$2 with plat\$3 and grind\$3 and laser and electrode | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 01:54 |
| S3 | 416 | electroless\$2 with plat\$3 and grind\$3 and laser and electrode and (resin or laminate) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 01:54 |
| S4 | 153 | electroless\$2 with plat\$3 and grind\$3 and laser and electrode and (resin or laminate) and bond\$3 and dic\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 01:55 |
| S5 | 227 | electroless\$2 with plat\$3 and (grind\$3 or polish\$3) and laser and electrode and (resin or laminate) and bond\$3 and dic\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 01:57 |
| S6 | 199 | electroless\$2 with plat\$3 and (grind\$3 or polish\$3) and laser and electrode and (resin) and bond\$3 and dic\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 01:57 |
| S7 | 200 | electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin) and bond\$3 and dic\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 01:59 |

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| S8 | 92 | electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin) and bond\$3 and dic\$3 and electroplat\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 15:49 |
| S9 | 746 | (438/460).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/15 02:05 |
| S10 | 758 | (438/459).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/15 02:06 |
| S11 | 620 | (438/675).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/15 02:06 |
| S12 | 752 | (438/678).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/15 02:06 |
| S13 | 289 | (438/674).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/15 02:06 |
| S14 | 7 | electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin with laminate) and bond\$3 and dic\$3 and electroplat\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 18:54 |
| S15 | 9 | SORIMACHI-HARUO.in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 18:26 |
| S16 | 23 | electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin with laminate) and electroplat\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/15 18:55 |